

(Rev. 6-93)
OMB NO. 0651-0011(exp.4/94)

Patent and Trademark Office
TAN-269



To the Honorable Commissioner of
Please record the attached orig:

101386498

JCT14 U.S. PTO
09/589769
06/09/00

1. Name of conveying party(ies):

Seiki YONESHIGE
Tomoyuki NAKANO
Reiji OHASHI

MPO
6.5.00

2. Name and address of receiving party(ies):

Name: Nippon Paper Industries Co., Ltd.

Internal Address: _____

Street Address: 4-1, Oji 1-chome

Kita-ku

City: Tokyo State: Japan ZIP: 114-0002

Additional name(s) of conveying party(ies)
attached? Yes No

Additional name(s) & address(es) attached? Yes No

3. Nature of Conveyance

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: June 5, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date
of the application is: June 5, 2000

A. Patent Application No.(s)

B. Patent No.(s)

09/589769

Additional numbers attached? Yes No

5. Name and address of party to whom
correspondence concerning document
should be mailed:

Name: SHERMAN & SHALLOWAY

Internal Address: _____

Street Address: _____

413 North Washington Street

City: Alexandria State: VA

ZIP: 22314

6. Total number of applications and patents
involved:..... [1]

7. Total fee (37 CFR 3.41).....\$40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any
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06/19/2000
02 FC:581

Robert L. Haines
Name of Person Signing

40.00 DP

[Signature]
Signature

June 9, 2000
Date

Total number of pages including cover sheet, attachments, and document [3]

ASSIGNMENT

WHEREAS, We, SEIKI YONESHIGE, TOMOYUKI NAKANO and REIJI OHASHI residing at c/o Central Research Laboratory of Nippon Paper Industries Co., Ltd., 21-1, Oji 5-Chome, Kita-ku, Tokyo 114-0002 Japan (hereinafter referred to as INVENTORS), have invented certain new and useful improvement in A THERMALLY SENSITIVE RECORDING MEDIUM; for which an application for United States Letter Patent was signed by us on _____ and assigned Serial Number _____.

WHEREAS, NIPPON PAPER INDUSTRIES CO., LTD., a corporation of JAPAN, having a principle place of business at 4-1, Oji 1-Chome, Kita-ku, Tokyo, 114-0002 Japan, (hereinafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents do sell, assign and transfer unto said Company, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United State and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company, as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the said Company, its successors and assigns.

FURTHER, We agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Companies, its successors and assigns, to obtain and enforce proper protection for said Invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, We have hereunto set our hands this
5th day of June, 2000.

Signed in the presence of:

Witness: Hiroshi Tanaka Signed: Seiki Yoneshige

Witness: Yori Tomota Signed: Tomoyuki Nakano

Signed: Reiji Aashi